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(71) Applicant: **ABIOMED EUROPE GMBH** [DE/DE];
Neuenhofer Weg 3, 52074 Aachen (DE).

(72) Inventors: **NIX, Christoph**; c/o ABIOMED Europe GmbH, Neuenhofer Weg 3, 52074 Aachen (DE). **RA-JARAM, Mithun**; c/o ABIOMED Europe GmbH, Neuenhofer Weg 3, 52074 Aachen (DE). **ZSCHERLICH, Verena**; c/o ABIOMED Europe GmbH, Neuenhofer Weg 3, 52074 Aachen (DE).

(74) Agent: **GROSSE SCHUMACHER KNAUER VON HIRSCHHAUSEN**; Nymphenburger Str. 14, 80335 München (DE).

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(54) Title: ELECTRODE ASSEMBLY PATCH FOR CONDUCTANCE AND ADMITTANCE MEASUREMENTS

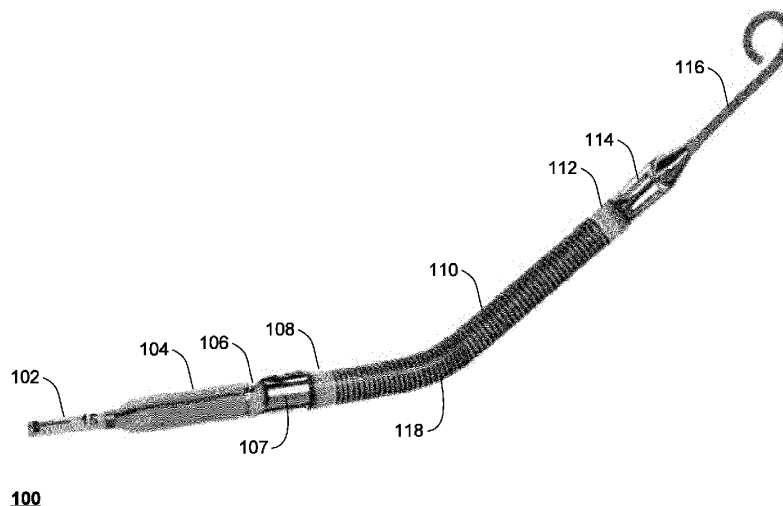


FIG. 1

(57) Abstract: Electrode assembly patches configured for conductance and admittance measurements, and methods of manufacturing same. The present technology provides designs and manufacturing methods that may enable a conductance or admittance electrode assembly patches to be flexible, low-profile, and easily applied to an intravascular blood pump or other device, such that there may be little or no change to the device's overall diameter, profile, and functionality.

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